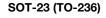
# **SQ2315ES**



**Vishay Siliconix** 

# Automotive P-Channel 12 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-12			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 V$	0.050			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -2.5 V$	0.068			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -1.8 \text{ V}$	0.100			
I <sub>D</sub> (A)	-5			
Configuration	Single			
Package	SOT-23			



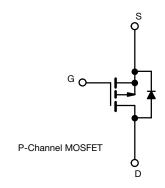


### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified <sup>c</sup>
- 100 % R<sub>q</sub> and UIS tested
- Compliant to RoHS Directive 2002/95/EC
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



Marking Code: 8D

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> =	25 °C, unles	s otherwise noted	)	
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	-12	V
Gate-Source Voltage		V <sub>GS</sub>	± 8	v
Continuous Drain Current	T <sub>C</sub> = 25 °C	I_	-5	
	T <sub>C</sub> = 125 °C	l <sub>D</sub>	-3	
Continuous Source Current (Diode Conduction)		I <sub>S</sub>	-2.5	А
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	-20	
Single Pulse Avalanche Current		I <sub>AS</sub>	-11	
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	6	mJ
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	PD	2	W
	T <sub>C</sub> = 125 °C	L.D	0.67	vv
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>b</sup>	R <sub>thJA</sub>	175	°C/W
Junction-to-Foot (Drain)		R <sub>thJF</sub>	75	0/W

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. When mounted on 1" square PCB (FR4 material).

c. Parametric verification ongoing.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = -250 μA	-12	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D$ = -250 $\mu$ A	-0.45	-	-1	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	= 0 V, V <sub>GS</sub> = ± 8 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = -12 V	-	-	-1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -12 V, T <sub>J</sub> = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = -12 V, T <sub>J</sub> = 175 °C	-	-	-150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = -4.5 V$	$V_{DS} \le -5 V$	-10	-	-	А
		$V_{GS} = -4.5 V$	I <sub>D</sub> = -3.5 A	-	0.042	0.050	
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -3.5 A, T <sub>J</sub> = 125 °C	-	-	0.066	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 V$	I <sub>D</sub> = -3.5 A, T <sub>J</sub> = 175 °C	-	-	0.075	Ω
		V <sub>GS</sub> = -2.5 V	I <sub>D</sub> = -3 A	-	0.059	0.068	
		V <sub>GS</sub> = -1.8 V	I <sub>D</sub> = -2 A	-	0.084	0.100	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= -5 V, I <sub>D</sub> = -1.6 A	-	7	-	S
Dynamic <sup>b</sup>		-					
Input Capacitance	C <sub>iss</sub>			-	695	870	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = -6 V, f = 1 MHz	-	265	335	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			-	190	240	
Total Gate Charge <sup>c</sup>	Qg			-	9	13	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = -4.5 V	$V_{GS} = -4.5 V$ $V_{DS} = -6 V$ , $I_D = -3.85 A$		1	-	nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	2.4	-	
Gate Resistance	Rg	f = 1 MHz		2.4	4.9	12.3	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	17	26	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, \text{ R}_{\text{L}} = 1.6 \Omega$ $\text{I}_{\text{D}} \cong -3.85 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	19	29	ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	28	42	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	13	20	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	-20	А
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =	-2 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

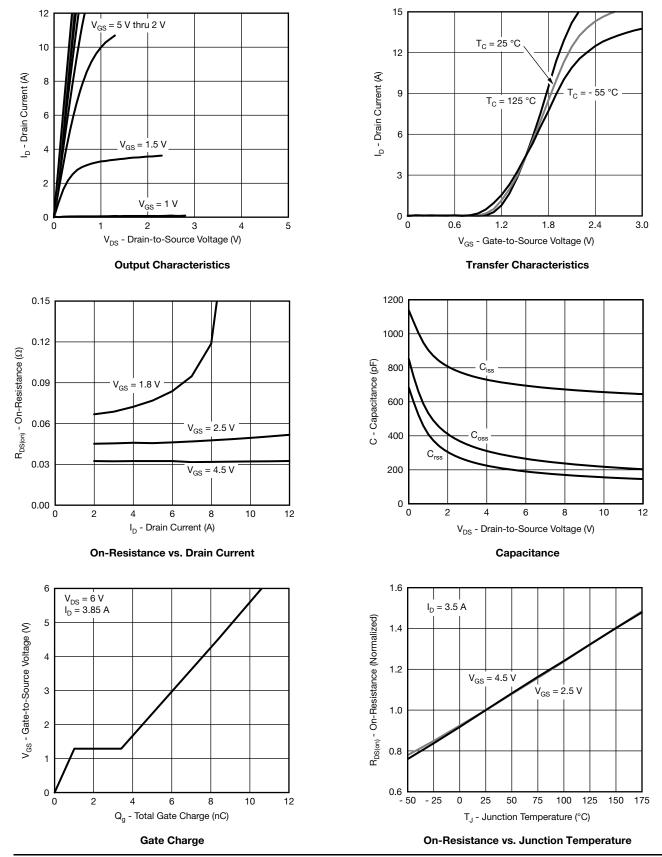
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



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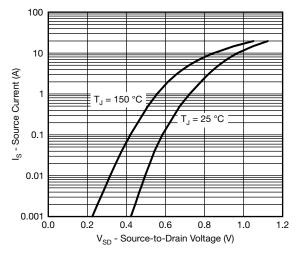
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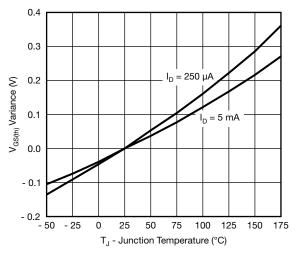
## **SQ2315ES**

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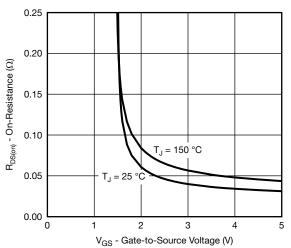
## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



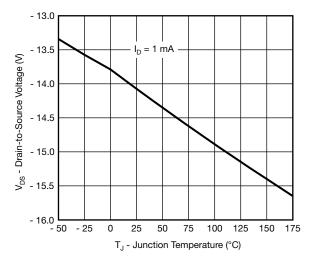
Source-Drain Diode Forward Voltage



**Threshold Voltage** 

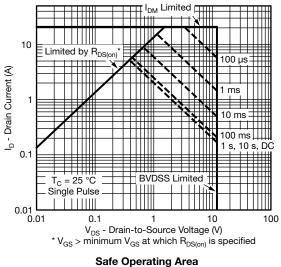


**On-Resistance vs. Gate-to-Source Voltage** 



Drain Source Breakdown vs. Junction Temperature

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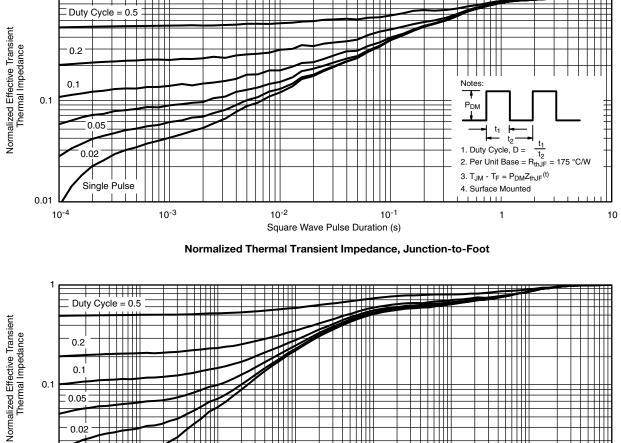
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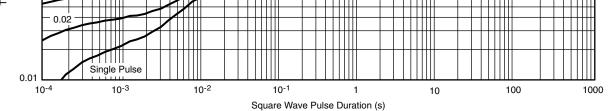


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## **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)







#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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# **SQ2315ES**

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#### **REVISION HISTORY**<sup>a</sup>

REVISION	DATE	DESCRIPTION OF CHANGE	
D	06-Oct-15	• R <sub>DS(on)</sub> and R <sub>g</sub> changed	

Note

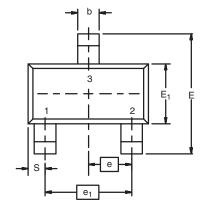
a. As of April 2014

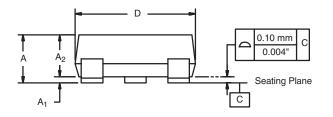


# **Package Information**

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## SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
Dim	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# Application Note 826

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### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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